

CompactPCI™ Prototyping Boards

Models 836 and 875

Features

- Model 875 is 3U x 160mm
- Model 836 is 6U x 160mm
- Compatible with PICMG 2.0 Revision 2.1
- Supplied with all 2mm connectors installed
- 0.1 inch Pin Grid Array
- 0.041 inch grid pitch
- High-current +5VDC and Ground grids
- Power connections included for all compactPCI voltages
- 2 oz copper power and ground planes reduce voltage drop
- 1101.10 front panel included

Overview

CompactPC/TM Prototyping Boards

Models 875 and 836 CompactPCI™cPCI prototyping boards are another in the growing line of quality test and development accessories available from Dawn VME Products.

Manufactured from high-quality FR4, epoxy-glass laminate, **Models 875 and 836** are sturdy and reliable methods for system prototyping, product development and even low-quantity production requirements.

The J1 and J2 connectors are factory installed to this PICMG 2.0 R 2.1 compliant prototyping board. Dawn offers a superior-quality IEEE 1101.10 front panel for installation convenience.

Ordering Numbers

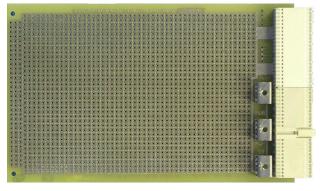
Model 875 (3U)	11-1010875
Model 836 (6U)	11-1010836

Technical Specifications

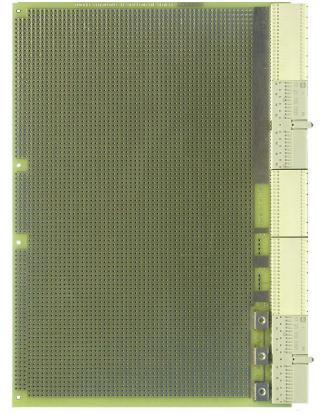
<u>Mechanical</u>

Compatibility: PICMG Specification 2.0 Revision 2.1 PCB Material: FR4 and fully compliant with IPC-4101/26 PCB Design Construction: High-performance microstrip Power and Ground Planes: 2 oz copper Weight: 1.7 oz

Model 875



Model 836



Environmental

Storage Temperature: -20°C to +85°C Operating Temperature: 0°C to +50°C Humidity: <95% non-condensing MTBF: >300,000 hr operating at +40°C